

SMT350

User Manual



Certificate Number FM 55022

Revision History

	Changes Made	Issue	Initials
11/10/05	Original Document.	1.0	PSR
18/01/06	Updates on ADC inputs and DAC outputs (impedances)	1.1	PSR
25/01/06	Added details on PHSTR synch.	1.2	PSR
31/10/06	Dac Trigger was missing. Corrected 0x0 and 0x1C register descriptions.	1.3	PSR
11/12/06	LED description added as well as J1 description.	1.4	PSR
25/01/2007	Connector list added; Control structure corrected.	1.5	PSR
05/02/2007	Figure 6 corrected.	1.6	PSR
21/02/2007	Scratch Test register description corrected. ADC PLL register (0x2) corrected.	1.7	PSR
23/03/2007	Details added to the clock circuitry.	1.8	PSR
18/12/2007	Ordering Information added	1.9	PSR

Table of Contents

Physical Properties	6
Ordering Information.....	6
Precautions	7
Introduction	8
Overview	8
Module features	8
Possible applications	9
Related Documents	9
Functional Description	10
Block Diagram.....	10
Module Description	10
ADC Channels.	12
ADC Main Characteristics.	12
ADC Input Stage.	12
Dual-Channel DAC.	13
DAC Main characteristics.....	13
DAC output stage.....	13
Clock Structure.....	14
Power Supply and Reset Structure.....	17
JumperJ1	17
Green LEDs.	17
Mezzanine module Interface.....	17
Control Register Settings.....	25
Control Packet Structure.....	25
Reading and Writing Registers	25
Memory Map	26
Register Descriptions.....	27
Reset Register – 0x0.....	27
Test Register – 0x1.	28
ADCA Register 0 – 0x2.	28
ADCA Register 1 – 0x3.	28
ADCA Register 2 – 0x4.	29

ADCB Register 0 – 0x5	29
ADCB Register 1 – 0x6	29
ADCB Register 2 – 0x7	30
DAC Register 0 – 0x8	30
DAC Register 1 – 0x9	30
DAC Register 2 – 0xA	31
DAC Register 3 – 0xB	31
DAC Register 4 – 0xC	31
DAC Register 5 – 0xD	31
DAC Register 6 – 0xE	32
DAC Register 7 – 0xF	32
CDCM7005 Register 0 – 0x10	32
CDCM7005 Register 1 – 0x11	32
CDCM7005 Register 2 – 0x12	33
CDCM7005 Register 3 – 0x13	33
CDCM7005 Register 4 – 0x14	33
CDCM7005 Register 5 – 0x15	33
CDCM7005 Register 6 – 0x16	34
CDCM7005 Register 7 – 0x17	34
Main Module Temperature (not implemented) – 0x18	34
Main Module FPGA Temperature (not implemented) – 0x19	34
Mezzanine Module Temperature (not implemented) – 0x1A	34
Mezzanine Module Converters Temperature (not implemented) – 0x1B	35
Miscellaneous Register – 0x1C	35
Updates, Read-back and Firmware Version Registers – 0x1D	36
DDS Register 0 – Start Phase Increment LSB - 0x20	37
DDS Register 1 – Start Phase Increment MSB - 0x21	37
DDS Register 2 – Stop Phase Increment LSB - 0x22	38
DDS Register 3 – Stop Increment MSB - 0x23	38
DDS Register 0 – Step Phase Increment LSB - 0x24	38
DDS Register 5 – Step Increment MSB - 0x25	39
FPGA Design	40
Serial Interfaces	40

Block of registers	41
Space available in FPGA	41
PCB Layout.....	42
Connectors	44
Description	44
Location on the board	45

Table of Figures

Figure 1 – Fan across PCI.	7
Figure 2 - Block Diagram.....	10
Figure 3 - Main features.	12
Figure 4 - ADC Input Stage.....	12
Figure 5 - DAC Output Stage.	14
Figure 6 - Clock Structure.	14
Figure 7 - External Clock.....	16
Figure 8 - Clock Architecture Main Characteristics.	17
Figure 9 – Mezzanine module Connector Interface (SLB data and power connectors).....	18
Figure 10 – Mezzanine Module Interface Power Connector and Pinout.	20
Figure 11 – Daughter Module Interface: Data Signals Connector and Pinout (Bank A).	21
Figure 12 – Daughter Module Interface: Data Signals Connector and Pinout (Bank B).	23
Figure 13 – Daughter Module Interface: Data Signals Connector and Pinout (Bank C).	24
Figure 14 – Setup Packet Structure.	25
Figure 15 – Control Register Read Sequence.	25
Figure 16 – Register Memory Map.....	27
Figure 17 - Firmware Block Diagram.....	40
Figure 18 - Space available in FPGA	41
Figure 19 – Main Module Component Side.....	42
Figure 20 - Main Module (<i>SMT368</i>) Solder Side.....	42
Figure 21 - Daughter Module Component Side.....	43
Figure 22 - Daughter Module Solder Side.....	43
Figure 23 - Connectors Location.	45

Physical Properties

Dimensions	63.5mm x 106.7mm x 18mm	
Weight	35 grams	
Supply Voltages		
Supply Current	+12V	N/A
	+5V	1.2 Amps (reset / converters active) 1.4 Amps max
	+3.3V	0.14 Amp (reset / converters active) 0.4 Amps max
	-5V	N/A
	-12V	N/A
MTBF		

Ordering Information

SMT350 (Standard Product): ADC inputs and DAC outputs are AC-coupled.

SMT350-DC: ADCs inputs are DC-coupled and DAC outputs are AC-coupled.

Precautions

In order to guarantee that Sundance's boards function correctly and to protect the module from damage, the following precautions should be taken:

- They are static sensitive products and should be handled accordingly. Always place the modules in a static protective bag during storage and transition.

- When operated in a closed environment make sure that the heat generated by the system is extracted e.g. a fan extracting heat or blowing cool air. Sundance recommends and uses PAPST 12-Volt fans (Series 8300) producing an air flow of 54 cubic meters per hour (equivalent to 31.8 CFM). Fans are placed so they blow across the PCI bus as show on the following picture:



Figure 1 – Fan across PCI.

Introduction

Overview

The *SMT350* is a single width expansion TIM that plugs onto the [SLB](#) base module [SMT368](#) (Virtex-4 FPGA) and incorporates 2 [Texas Instrument](#) Analog-to-Digital Converters ([ADS5500](#)) and a Texas Instrument dual-channel Digital-to-Analog Converter ([DAC5686](#)). The *SMT350* implements a comprehensive clock circuitry based on a [CDCM7005](#) chip that allows synchronisation among the converters and cascading modules for multiple receiver or transmitter systems as well as the use of an external reference clock. It provides a complete conversion solution and stands as a platform that can be part of a transmit/receive base station.

ADCs are 14-bit and can sample at up to 125 MHz. The DAC has a resolution of 16 bits and is able to update outputs at up to 500MHz. All converters are 3.3-Volt.

The [Xilinx FPGA](#) (Virtex-4) on the base module is responsible for handling data going/coming to/from one of the following destination/source: TI converters, Comport ([TIM-40 standard](#)), Sundance High-speed Bus ([SHB](#)). These interfaces are compatible with a wide range of Sundance's modules.

The memory on base module can be divided into two 16-bit wide independent blocks for storing incoming and/or outgoing samples.

Converter configuration, sampling and transferring modes are set via internal control registers stored inside the FPGA and accessible via Comport.

Module features

The main features of the *SMT350* are listed below:

- Dual 14-bit 125MSPS ADC ([ADS5500](#)),
 - Dual channel 16-bit 500MSPS DAC ([DAC5686](#)),
 - On-board low-jitter clock generation ([CDCM7005](#)),
 - One external clocks, two external triggers and one reference clock via [MMCX](#) connector,
 - One [SLB](#) connector to link *SMT350* and *SMT368*,
 - Synchronisation signals,
 - All Analogue inputs to be connected to 50-Ohm sources.
 - All Analogue outputs to be connected to 50-Ohm loads.
 - Temperature sensors.
-

Possible applications

The *SMT350* can be used for the following application (this non-exhaustive list should be taken as an example):

- High Intermediate-Frequency (IF) sampling architecture,
- Cellular base station such as CDMA and TDMA,
- Baseband I&Q systems,
- Wireless communication systems,
- Communication instrumentation,
- ...

Related Documents

ADS5500 Datasheet – Texas Instrument:

<http://focus.ti.com/docs/prod/folders/print/ads5500.html>

DAC5686 Datasheet – Texas Instrument:

<http://focus.ti.com/docs/prod/folders/print/dac5686.html>

CDCM7005 Datasheet – Texas Instrument:

<http://focus.ti.com/docs/prod/folders/print/cdcm7005.html>

Sundance High-speed Bus (SHB) specifications – Sundance.

ftp://ftp2.sundance.com/Pub/documentation/pdf-files/SHB_Technical_Specification.pdf

Sundance LVDS Bus (SLB) specifications – Sundance.

<http://www.sundance.com/docs/SLB%20-%20Technical%20Specifications.pdf>

TIM specifications.

ftp://ftp2.sundance.com/Pub/documentation/pdf-files/tim_spec_v1.01.pdf

Xilinx Virtex-4 FPGA.

<http://direct.xilinx.com/bvdocs/publications/ds031.pdf>

MMCX Connectors – Hubert Suhner.

[MMCX Connectors](#)

[Surface Mount MMCX connector](#)

Sundance Multiprocessor Technology Ltd.

[SMT368](#)

Functional Description

In this part, we will see the general block diagram and some comments on some the *SMT350* entities.

Block Diagram

The following diagram describes the architecture of the *SMT350*, coupled – as an example – with an *SMT368* to show how mezzanine and base modules are connected together:

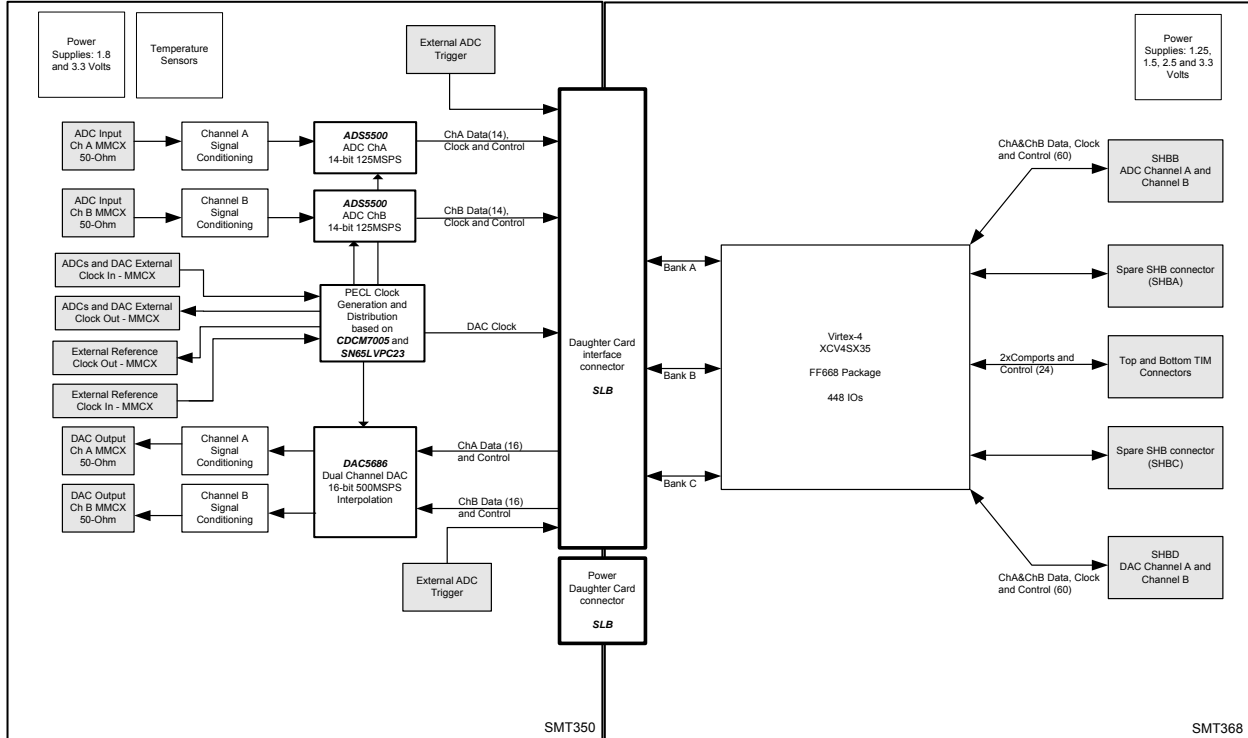


Figure 2 - Block Diagram.

Module Description

The module is built around two [TI ADS5500](#) 14-bit sampling analog-to-digital converters and one [TI DAC5686](#) dual 16-bit digital-to-analog converter.

ADCs: Analog data enters the module via two MMCX connectors, one for each channel. Both signals are then conditioned (AC coupling; DC optional) before being digitized. Both ADCs get their own sampling clock, which can be either on-board generated or from an external reference or an external clock, common to ADCs and DAC (MMCX connector). Digital samples travel to the FPGA on the base module via

the inter-module connector ([SLB](#) – Sundance LVDS Bus, used in this case as 'single-ended').

DAC: Digital samples are routed from the FPGA to the DAC via the inter-module connector. Internal interpolation scheme allows reaching 500 Mega Samples per Second. The DAC shows other modes such as Dual DAC, Single side-band, Quadrature or up conversion. Both outputs are AC-coupled. By default they are single-ended but can optionally be differential. The DAC mode is selected via Jumper J1, that enables or disables the DAC Internal PLL (see DAC5686 datasheet for more details).

Clock generator and distribution: All samplings clocks are generated by the same chip. It allows having them all synchronized to a single reference clock.

Multi-module Synchronization: There are two types of synchronization available on the *SMT350*. The first one is frequency synchronization, by passing the external reference clock to an other module. It first goes through a 0-delay buffer and is then output. Note that the synchronization is in frequency and not in phase. The second type is register synchronization between DACs. It is achieved by the way of an extra link between several modules to synchronize DAC internal registers (DAC signal PHSTR passed from one module to the other and driven by the master FPGA – it resets the internal VCO).

Inter-module Connector: it is made of a power (33 pins) and data connectors (120 pins). It is called **Sundance LVDS Bus**. Please refer to [the SLB specifications](#) for more details. In the case of the SMT350, the SLB is used as 'single-ended'.

A global reset signal is mapped to the FPGA from the bottom TIM connector.

External Clock signals, used to generate Sampling clocks. There is one external clock, common to ADCs and DAC. When used, the CDCM7005 is used as a clock multiplexer. Also available, an external reference clock that can be passed to an other SMT350 module with '0-delay'.

External Trigger: passed directly to base module. There are two, one for the ADCs and one for the DAC.

Temperature Sensor: available for constant monitoring. Not part of default firmware provided.

ADC Channels.

ADC Main Characteristics.

The main characteristics of the SMT350 ADCs are gathered into the following table.

Analogue Inputs	
Input voltage range	2.4 Vp-p (11.5 dbm – 50 Ohm) Full scale - AC coupled
Impedance	ADC single-ended inputs are to be connected to a 50Ω source. Source impedance matching implemented between RF transformers and ADC.
Bandwidth	ADC bandwidth: 750 MHz.
ADCs Output	
Output Data Width	14-Bits
Data Format	2's Compliment or offset binary (Changeable via control register)
SFDR	82dBs maximum (manufacturer)
SNR	70dBs maximum (manufacturer)
Minimum Sampling Clock	10 MHz (ADC DLL off)
Maximum Sampling Frequency	125 MHz (ADC DLL on)

Figure 3 - Main features.

ADC Input Stage.

Each ADC Analogue input is AC-coupled via and RF transformer. The 50-Ohm resistor between the connector and the first RF transformer is not fitted because the source impedance match is implemented between the second RF transformer and the ADC by the way of two 25-Ohm resistors.

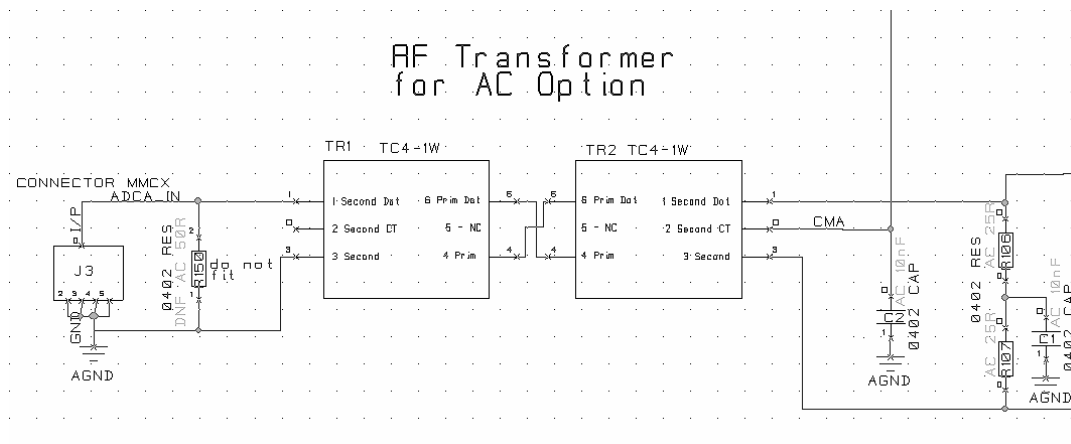


Figure 4 - ADC Input Stage.

Dual-Channel DAC.

DAC Main characteristics.

The main characteristics of the SMT350 DAC are gathered into the following table.

Analogue Outputs	
Input voltage range	1 V _{p-p} – Full scale - AC coupled
Impedance	DAC single-ended outputs are to be connected to a 50Ω load, which impedance matching implemented between DAC and RF transformers.
Bandwidth	TBD
DAC Input	
Output Data Width per channel	16-Bits
Data Format	2's Compliment or offset binary (Changeable via control register)
SFDR	89dBs maximum (manufacturer)
SNR	80dBs maximum (manufacturer)
Maximum input data rate	160 MSPS (Clk1 – DAC5686)
Maximum Sampling rate	500 MSPS (Clk2 – DAC5686)

Jumper J1 disables (position 1-2; also called External Clock Mode) or enables (position2-3; also called Internal Clock Mode) the DAC internal PLL.

DAC output stage.

The following piece of schematics shows how the DAC outputs are coupled. The DAC5686 generates differential output signals that are fed into an RF transformer (Ohm ratio 4), that makes both DAC channels AC coupled. 100-Ohm resistors to V_{cc} on the primary stage of the transformer allow balancing the secondary stage to 50 Ohm single-ended. (Note that R153 is not mounted).

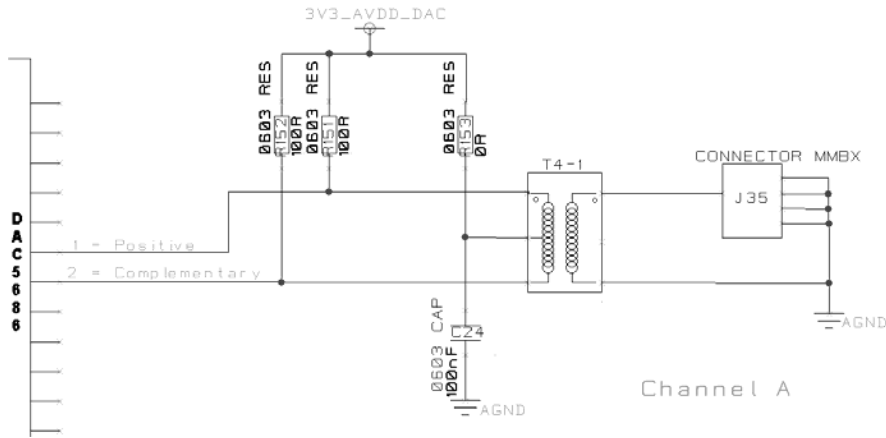


Figure 5 - DAC Output Stage.

Clock Structure

There is one integrated clock generator on the module (CDCM7005 – Texas instrument). The user can either use this clock (on-board) or provide the module with an external clock (input via MMCX connector).

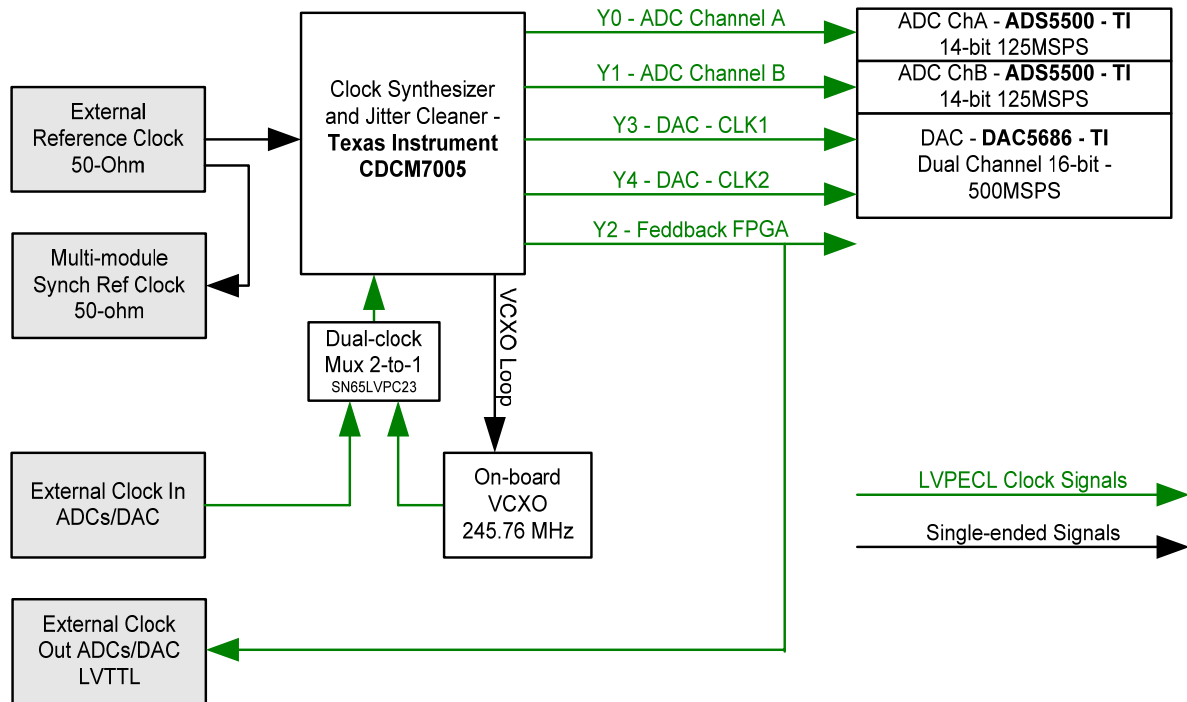


Figure 6 - Clock Structure.

ADCs can both receive the same clock or the fraction of the CDCM7005 input clock ($/2$, $/3$, $/4$, $/6$, $/8$ or $/16$), the maximum being 125MHz for each ADC. This input clock can be coming from the on-board fixed VCXO or from an external source. Here is a list of possible sampling frequencies for the ADCs:

ADC Sampling Frequency	CDCM7005 Setting	Clock source
Not Allowed	$/1$	On-board VCXO (fixed 245.76MHz)
122.88 MHz	$/2$	On-board VCXO (fixed 245.76MHz)
81.92 MHz	$/3$	On-board VCXO (fixed 245.76MHz)
61.44 MHz	$/4$	On-board VCXO (fixed 245.76MHz)
40.96 MHz	$/6$	On-board VCXO (fixed 245.76MHz)
30.72 MHz	$/8$	On-board VCXO (fixed 245.76MHz)
15.36 MHz	$/16$	On-board VCXO (fixed 245.76MHz)
Anything between 10 and 125 MHz	$/1$, $/2$, $/3$, $/4$, $/6$, $/8$ or $/16$	External Clock

The same applies to the DAC, with a maximum sampling frequency for clk1 of 160MHz and for clk2 of 500MHz.

Below is shown how the external clock is fed to the system. By default it is single-ended and AC-coupled before being converted into LVPECL format. The option of having a differential external clock is still possible on the hardware by the way of fitting or not some of the components.

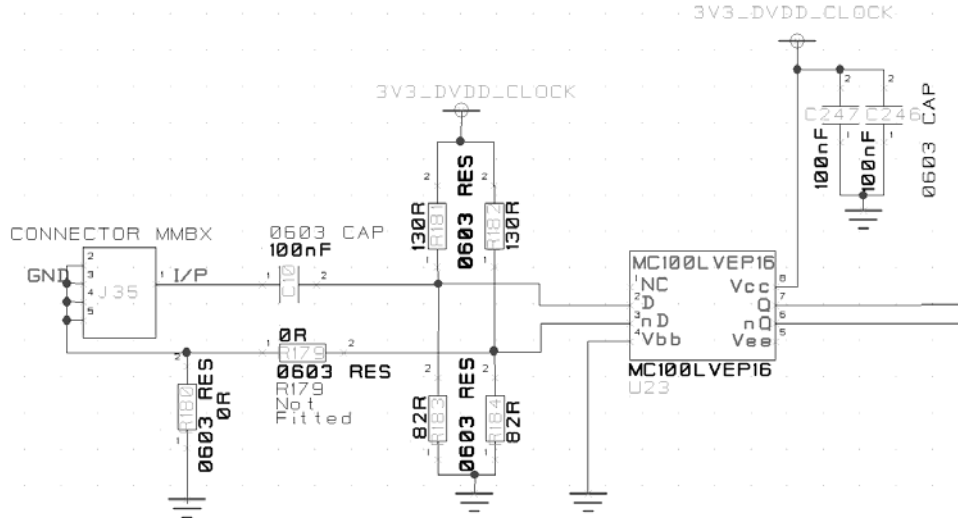


Figure 7 - External Clock.

The main characteristics of the *SMT350* Clocks are gathered into the following table.

External Reference Input	
Input Voltage Level	0.5 – 3.3 Volts peak-to-peak (AC-coupled)
Input Impedance	50-Ohm (Termination implemented at the connector)
Frequency Range	0 – 100 MHz.
External Reference Output	
Output Voltage Level	1.6 Volts peak-to-peak (AC-coupled)
Output Impedance	50-Ohm (Termination implemented at the connector)
External Sampling Clock Input	
Input Voltage Level	0.5 – 3.3 Volts peak-to-peak (AC-coupled)
Input Format	Single-ended or differential on option (3.3V LVPECL).
Frequency range	10-500 MHz
External Sampling Clock Output	
Output Voltage Level	0-2.4 Volts fixed amplitude
Output Format	LVTTL
External Trigger Inputs	
Input Voltage Level	1.5-3.3 Volts peak-to-peak.
Format	DC-coupled and Single-ended (Termination implemented at the connector). Differential

	on option (3.3 V PECL).
Impedance	50-Ohm.
Frequency range	62.5 MHz maximum
Delay	
External Ref. Input to Ext Ref. Out	
External Clk Input to Ext Clk Out	9ns (between J29 and J4)

Figure 8 - Clock Architecture Main Characteristics.

Power Supply and Reset Structure

The *SMT350* gets two power sources from the base module: 3.3 and 5 Volts. Linear regulators are used to provide a clean and stable voltage supply to the analog converters.

Jumper J1

There is one jumper (3 pin header) on the board. It is to control the power supply of the DAC internal PLL. When fitted on positions 2 and 3, the PLL is enabled, whereas on positions 1 and 2, it is disabled. Please refer to the DAC5686 datasheet for more details.

Green LEDs.

There are 7 LEDs on the *SMT350* Daughter Module. Five are dedicated for power supplies monitoring: LED1 (1.8V DAC), LED2 (3.3V Clock), LED3 (3.3V DAC), LED4 (3.3V ADCA), LED6 (3.3V ADCB) should be all ON when the board is under power. They state that power supplies all work fine.

LED5 (ADCs) should be flashing once the ADC Clocks are set up. It is actually a divided version of ADCA sampling clock). LED7 (DAC) is a divided version of PLLLOCK coming from the Dac (DAC5686).

Mezzanine module Interface

The daughter module interface is made up of two connectors (data and power). The first one is a 0.5mm-pitch differential Samtec connector. This connector is for transferring data such as ADC or DAC samples to and from the FPGA on the main module. The second one is a 1mm-pitch Samtec header type connector. This connector is for providing power to the daughter-card.

Sundance defines these two connectors as the **Sundance LVDS Bus (SLB)**. It has originally been made for data transfers using LVDS format but can also be used with single-ended lines, which is the case for the *SMT350*. To know more about the SLB, please refer to [the SLB specifications](#).

The figure underneath illustrates this configuration. The bottom view of the daughter card is shown on the right. This view must be mirrored to understand how it connects to the main module.

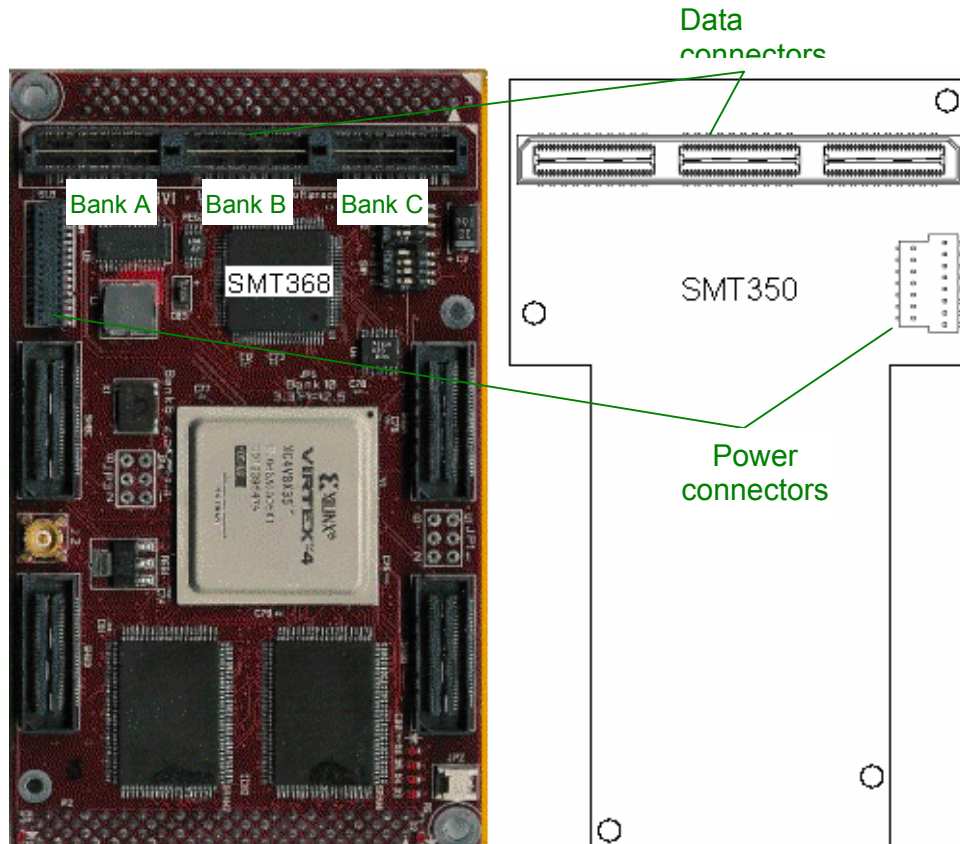


Figure 9 – Mezzanine module Connector Interface (SLB data and power connectors).

The female differential connector is located on the base module. The Samtec Part Number for this connector is QTH-060-01-F-D-DP-A.

The female power connector is located on the base module. The Samtec Part Number for this connector is BKS-133-03-F-V-A

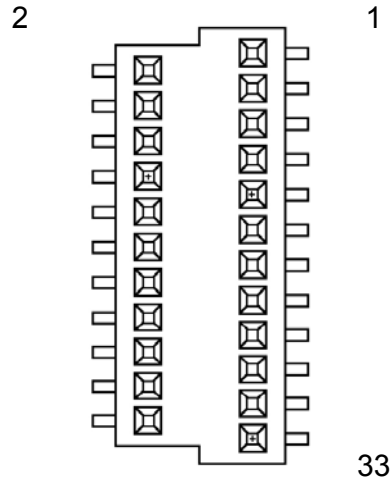
The male differential connector is located on the mezzanine card. The Samtec Part Number for this connector is QSH-060-01-F-D-DP-A

The male power connector is located on the mezzanine card. The Samtec Part Number for this connector is BKT-133-03-F-V-A

The mated height between the main module and the daughter card is 5 mm.

Some JTAG Lines are also mapped onto this connector to be used in case the Daughter module would have a TI Processor. They would allow debugging and programming via JTAG.

The following table shows the pin assignment on the power connector:

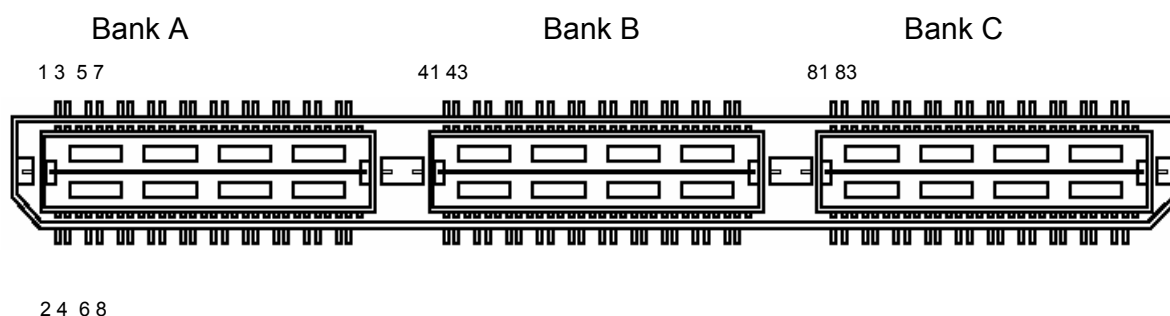


Pin Number	Pin Name	Description of Signal
1	D+3V3	Digital 3.3 Volts
2	DGND	Digital Ground
3	D+3V3	Digital 3.3 Volts
4	DGND	Digital Ground
5	D+3V3	Digital 3.3 Volts
6	DGND	Digital Ground
7	D+3V3	Digital 3.3 Volts
8	DGND	Digital Ground
9	D+5V0	Digital 5.0 Volts
10	DGND	Digital Ground
11	D+5V0	Digital 5.0 Volts
12	DGND	Digital Ground
13	D+5V0	Digital 5.0 Volts
14	DGND	Digital Ground
15	D+5V0	Digital 5.0 Volts
16	DGND	Digital Ground
17	D+12V0	Digital +12.0 Volts – not used on the SMT350
18	DGND	Digital Ground
19	D+12V0	Digital +12.0 Volts – not used on the SMT350
20	DGND	Digital Ground

21	D-12V0	Digital –12.0 Volts – not used on the SMT350
22	DGND	Digital Ground
23	D-12V0	Digital –12.0 Volts – not used on the SM350
24	DGND	Digital Ground
25	DGND	Digital Ground
26	EMU0	Emulation Control 0 – not used on SMT350
27	EMU1	Emulation Control 1 – not used on SMT350
28	TMS	JTAG Mode Control – not used on SMT350
29	nTRST	JTAG Reset – not used on SMT350
30	TCK	JTAG Test Clock – not used on SMT350
31	TDI	JTAG Test Input – not used on SMT350
32	TDO	JTAG Test Output – not used on SMT350
33	DGND	Digital Ground

Figure 10 – Mezzanine Module Interface Power Connector and Pinout.

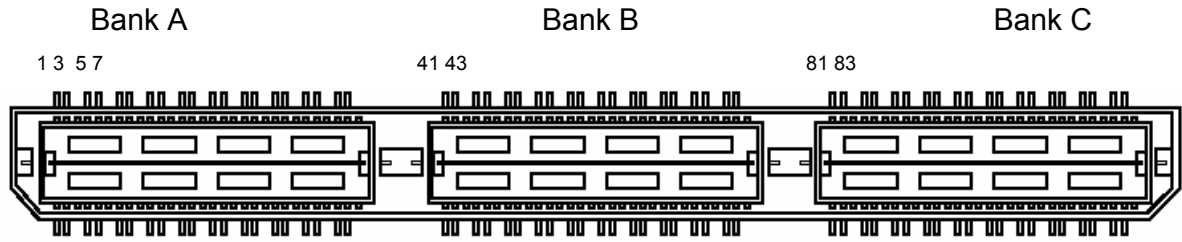
The following few pages describes the signals on the data connector between the main module and the daughter card. Bank A on the connector is used for the ADC Channels A and B. Bank C is used for the DAC channels A and B. Bank B is used for system clock and trigger signals, ADC/DAC/Clock control signal.



Bank A (ADCs)

Pin No	Pin Name	Signal Description	Pin No	Pin Name	Signal Description
Dir	Daughter Card to Main Module		Dir	Daughter Card to Main Module	
1	DOAI0p	Data Out 0, Channel A.	2	DOBI0p	Data Out 1, Channel A.
3	DOAI0n	Data Out 2, Channel A.	4	DOBI0n	Data Out 3, Channel A.
Dir	Daughter Card to Main Module		Dir	Daughter Card to Main Module	
5	DOAI1p	Data Out 4, Channel A.	6	DOBI1p	Data Out 5, Channel A.
7	DOAI1n	Data Out 6, Channel A.	8	DOBI1n	Data Out 7, Channel A.
Dir	Daughter Card to Main Module		Dir	Daughter Card to Main Module	
9	DOAI2p	Data Out 8, Channel A.	10	DOBI2p	Data Out 9, Channel A.
11	DOAI2n	Data Out 10, Channel A.	12	DOBI2n	Data Out 11, Channel A.
Dir	Daughter Card to Main Module		Dir	Daughter Card to Main Module	
13	DOAI3p	Data Out 12, Channel A.	14	DOBI3p	Data Out 13, Channel A.
15	DOAI3n	Over Range, Channel A.	16	DOBI3n	Data Out 0, Channel B.
Dir	Daughter Card to Main Module		Dir	Daughter Card to Main Module	
17	DOAI4p	Data Out 1, Channel B.	18	DOBI4p	Data Out 2, Channel B.
19	DOAI4n	Data Out 3, Channel B.	20	DOBI4n	Data Out 4, Channel B.
Dir	Daughter Card to Main Module		Dir	Daughter Card to Main Module	
21	DOAI5p	Data Out 5, Channel B.	22	DOBI5p	Data Out 6, Channel B.
23	DOAI5n	Data Out 7, Channel B.	24	DOBI5n	Data Out 8, Channel B.
Dir	Daughter Card to Main Module		Dir	Daughter Card to Main Module	
25	DOAI6p	Data Out 9, Channel B.	26	DOBI6p	Data Out 10, Channel B.
27	DOAI6n	Data Out 11, Channel B.	28	DOBI6n	Data Out 12, Channel B.
Dir	Daughter Card to Main Module		Dir	Daughter Card to Main Module	
29	DOAI7p	Data Out 13, Channel B.	30	DOBI7p	Over Range, Channel B.
31	DOAI7n	Led ADC	32	DOBI7n	Status Lock CDCM7005
Dir	Daughter Card to Main Module		Dir	Daughter Card to Main Module	
33	ClkOlp	Data Clock Out, Channel A.	34	DOIRlp	Status VCXO CDCM7005
35	ClkOln	Data Clock Out, Channel B.	36	DOIRln	Status Ref CDCM7005
Dir	Reserved.		Dir	Reserved.	
37	Reserved.	Reserved.	38	Reserved	ADC External Trigger, P.
39	Reserved.	Reserved.	40	Reserved	ADC External Trigger, N.

Figure 11 – Daughter Module Interface: Data Signals Connector and Pinout (Bank A).



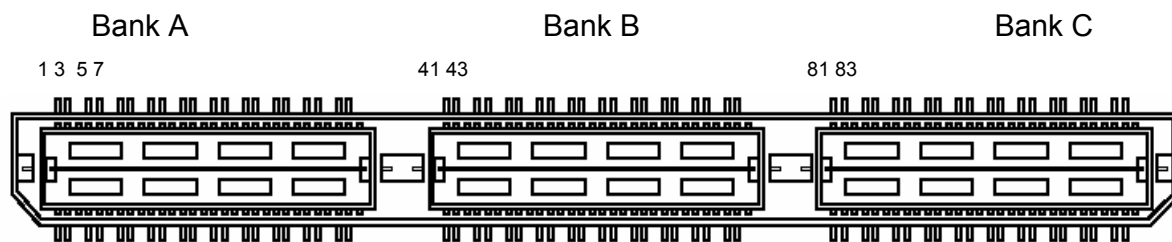
2 4 6 8

Bank B

Pin No	Pin Name	Signal Description	Pin No	Pin Name	Signal Description
Type			Clock and Trigger System Signals		
Dir	Daughter Card to Main Module		Dir	Daughter Card to Main Module	
41	SMBClk	Temperature Sensor Clock.	42	SMBData	Temperature Sensor Data.
43	SMBnAlert	Temperature Sensor Alert.	44	SerialNo	Reserved
Dir	Daughter Card to Main Module		Dir	Reserved	
45	AdcVdacI	Reserved	46	AdcVdacQ	Reserved
47	AdcVRes	Reserved	48	AdcReset	Reserved
Dir	Main Module to Daughter Card		Dir	Main Module to Daughter Card	
49	D3v3Enable	Reserved	50	D2v5Enable	Reserved
51	AdcMode	ADCA Serial Clock.	52	AdcClock	ADCA Serial Data.
Type			ADC Specific Signals		
Dir	Main Module to Daughter Card		Dir	Reserved	
53	AdcLoad	ADCA Serial Enable.	54	AdcData	ADCB Serial Clock.
55	AdcCal	ADCB Serial Data.	56	AdjClkCntr0	ADCB Serial Enable.
Dir	Main Module to Daughter Card		Dir	Main Module to Daughter Card	
57	AdjClkCntr1	ADCs Format (binary, 2's)	58	AdjClkCntr2	ADCs Reset
59	AdjClkCntr3	ADCs Output Enable	60	PllCntr0	CDCM7005 serial Enable.
Dir	Daughter Card to Main Module		Dir	Daughter Card to Main Module	
61	PllCntr1	CDCM7005 serial Clock.	62	PllCntr2	CDCM7005 serial Data.
63	PllCntr3	CDCM7005 Clock Selection.	64	AdcAClkSel	DAC PhStr.
Type			Module Control Signals		
Dir	Main Module to Daughter Card		Dir	Main Module to Daughter Card	
65	AdcBClkSel	DAC Reset.	66	IntClkDivEn	DAC Pll Lock.
67	IntClkDivnReset	DAC Serial Enable.	68	IntExtClkDivEn	DAC Serial Clock.
Dir	Main Module to Daughter Card		Dir	Main Module to Daughter Card	
69	IntExtClkDivnReset	DAC Serial Data.	70	FpgaVRef	Reserved
71	FpgaTck	Reserved	72	FpgaTms	Reserved
Dir	Daughter Card to Main Module		Dir	Reserved	
73	FpgaTdi	Reserved	74	FpgaTdo	Reserved
75	MspVRef	Reserved	76	MspTck	Reserved
Dir	Daughter Card to Main Module		Dir	Reserved	

77	MspTms	Reserved	78	MspTdi	Reserved.
79	MspTdo	Reserved	80	MspnTrst	Reserved

Figure 12 – Daughter Module Interface: Data Signals Connector and Pinout (Bank B).



2 4 6 8

Bank C (DAC)

Pin No	Pin Name	Signal Description	Pin No	Pin Name	Signal Description
Dir		Daughter Card to Main Module	Dir		Daughter Card to Main Module
81	DOAQ0p	Data In 0, Channel A.	82	DOBQ0p	Data In 1, Channel A.
83	DOAQ0n	Data In 2, Channel A.	84	DOBQ0n	Data In 3, Channel A.
Dir		Daughter Card to Main Module	Dir		Daughter Card to Main Module
85	DOAQ1p	Data In 4, Channel A.	86	DOBQ1p	Data In 5, Channel A.
87	DOAQ1n	Data In 6, Channel A.	88	DOBQ1n	Data In 7, Channel A.
Dir		Daughter Card to Main Module	Dir		Daughter Card to Main Module
89	DOAQ2p	Data In 8, Channel A.	90	DOBQ2p	Data In 9, Channel A.
91	DOAQ2n	Data In 10, Channel A.	92	DOBQ2n	Data In 11, Channel A.
Dir		Daughter Card to Main Module	Dir		Daughter Card to Main Module
93	DOAQ3p	Data In 12, Channel A.	94	DOBQ3p	Data In 13, Channel A.
95	DOAQ3n	Data In 14, Channel A.	96	DOBQ3n	Data In 15, Channel A.
Dir		Daughter Card to Main Module	Dir		Daughter Card to Main Module
97	DOAQ4p	Data In 0, Channel B.	98	DOBQ4p	Data In 1, Channel B.
99	DOAQ4n	Data In 2, Channel B.	100	DOBQ4n	Data In 3, Channel B.
Dir		Daughter Card to Main Module	Dir		Daughter Card to Main Module
101	DOAQ5p	Data In 4, Channel B.	102	DOBQ5p	Data In 5, Channel B.
103	DOAQ5n	Data In 6, Channel B.	104	DOBQ5n	Data In 7, Channel B.
Dir		Daughter Card to Main Module	Dir		Daughter Card to Main Module
105	DOAQ6p	Data In 8, Channel B.	106	DOBQ6p	Data In 9, Channel B.
107	DOAQ6n	Data In 10, Channel B.	108	DOBQ6n	Data In 11, Channel B.
Dir		Daughter Card to Main Module	Dir		Daughter Card to Main Module
109	DOAQ7p	Data Out 12, Channel B.	110	DOBQ7p	Data Out 13, Channel B.
111	DOAQ7n	Data Out 14, Channel B.	112	DOBQ7n	Data Out 15, Channel B.
Dir		Daughter Card to Main Module	Dir		Daughter Card to Main Module
113	Reserved.	DAC Clock P.	114	Reserved.	DAC LED.
115	Reserved.	DAC Clock N.	116	Reserved.	DAC Power Down.
Dir		Reserved.	Dir		Reserved.
117	Reserved.	Reserved.	118	Reserved.	DAC External Trigger, P.
119	Reserved.	Reserved.	120	Reserved.	DAC External Trigger, N.

Figure 13 – Daughter Module Interface: Data Signals Connector and Pinout (Bank C).

Control Register Settings

The Control Registers control the complete functionality of the *SMT350*. They are setup via the Comport3 (standard firmware provided). The settings of the ADC, triggers, clocks and the configuration of the SHB interfaces and the internal FPGA data path settings can be configured via the Control Registers.

Control Packet Structure

The data passed on to the *SMT350* over the Comport must conform to a certain packet structure. Only valid packets will be accepted and only after acceptance of a packet will the appropriate settings be implemented. Each packet will start with a command (4 bits – 0x1 for a write operation – 0x2 for a read operation) information, followed by a register address (12 bits – see table Memory Map), followed by a 16-bit data. This structure is illustrated in the following figure:

Byte Content								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
3	Command 3	Command 2	Command 1	Command 0	Address 11	Address 10	Address 9	Address 8
2	Address 7	Address 6	Address 5	Address 4	Address 3	Address 2	Address 1	Address 0
1	Data 15	Data 14	Data 13	Data 12	Data 11	Data 10	Data 9	Data 8
0	Data 7	Data 6	Data 5	Data 4	Data 3	Data 2	Data 1	Data 0

Figure 14 – Setup Packet Structure.

Reading and Writing Registers

Control packets are sent to the *SMT350* over Comport3. This is a bi-directional interface. The format of a 'Read Packet' is the same as that of a write packet.

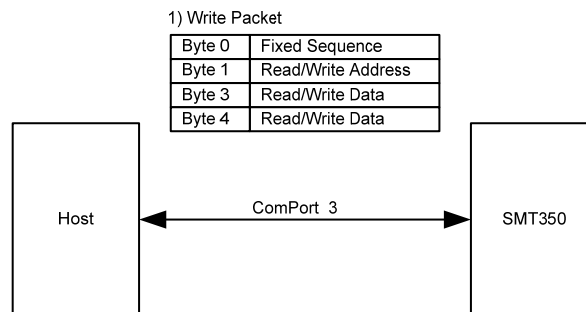


Figure 15 – Control Register Read Sequence.

Memory Map

The write packets must contain the address where the data must be written to and the read packets must contain the address where the required data must be read. The following figure shows the memory map for the writable and readable Control Registers on the *SMT350*:

Address	Writable Registers	Readable Registers
0x00	Reset Register.	Reserved.
0x01	Test Register.	Test Register.
0x02	ADCA Register 0.	Read-back (FPGA Register) ADCA Register 0.
0x03	ADCA Register 1.	Read-back (FPGA Register) ADCA Register 1.
0x04	ADCA Register 2.	Read-back (FPGA Register) ADCA Register 2.
0x05	ADCB Register 0.	Read-back (FPGA Register) ADCB Register 0.
0x06	ADCB Register 1.	Read-back (FPGA Register) ADCB Register 1.
0x07	ADCB Register 2.	Read-back (FPGA Register) ADCB Register 2.
0x08	DAC Register 0.	Read-back (FPGA Register) DAC Register 0.
0x09	DAC Register 1.	Read-back (FPGA Register) DAC Register 1.
0x0A	DAC Register 2.	Read-back (FPGA Register) DAC Register 2.
0x0B	DAC Register 3.	Read-back (FPGA Register) DAC Register 3.
0x0C	DAC Register 4.	Read-back (FPGA Register) DAC Register 4.
0x0D	DAC Register 5.	Read-back (FPGA Register) DAC Register 5.
0x0E	DAC Register 6.	Read-back (FPGA Register) DAC Register 6.
0x0F	DAC Register 7.	Read-back (FPGA Register) DAC Register 7.
0x10	CDCM7005 Register 0.	Read-back (FPGA Register) CDCM7005 Register 0.
0x11	CDCM7005 Register 1.	Read-back (FPGA Register) CDCM7005 Register 1.
0x12	CDCM7005 Register 2.	Read-back (FPGA Register) CDCM7005 Register 2.
0x13	CDCM7005 Register 3.	Read-back (FPGA Register) CDCM7005 Register 3.
0x14	CDCM7005 Register 4.	Read-back (FPGA Register) CDCM7005 Register 4.
0x15	CDCM7005 Register 5.	Read-back (FPGA Register) CDCM7005 Register 5.
0x16	CDCM7005 Register 6.	Read-back (FPGA Register) CDCM7005 Register 6.
0x17	CDCM7005 Register 7.	Read-back (FPGA Register) CDCM7005 Register 7.
0x18	Reserved	Main Module Temperature
0x19	Reserved	Main Module FPGA Temperature
0x1A	Reserved	Mezzanine Module Temperature
0x1B	Reserved	Mezzanine Module Converter Temperature
0x1C	Misc Register (Trigger, Clock Selection, etc...).	Read-back Misc Register.
0x1D	Update and Read-back command Register	Firmware Version and Status bits.
0x20	DDS Register 0 – Start Phase Increment LSB	Read-back (FPGA Register) DDS Register 0.
0x21	DDS Register 1 – Start Phase Increment MSB	Read-back (FPGA Register) DDS Register 1.
0x22	DDS Register 2 – Stop Phase Increment LSB	Read-back (FPGA Register) DDS Register 2.
0x23	DDS Register 3 – Stop Phase Increment MSB	Read-back (FPGA Register) DDS Register 3.

0x24	DDS Register 4 – Step Phase Increment LSB	Read-back (FPGA Register) DDS Register 4.
0x25	DDS Register 5 – Step Phase Increment MSB	Read-back (FPGA Register) DDS Register 5.

Figure 16 – Register Memory Map.

Register Descriptions

Reset Register – 0x0.

Reset Register – 0x0								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Reserved	Reserved	DDS Reset	PHSTR		CDCM7005 Reset	DAC Reset	ADCs Reset
Default	'0'	'0'	'1'	'00'		'1'	'1'	'1'

Reset Register – 0x0		
Setting	Bit 0	Description
0	0	Normal Operation.
1	1	Resets both ADC devices as well as their corresponding Serial Interfaces.
Setting	Bit 1	Description
0	0	Normal Operation.
1	1	Resets both DAC device as well as its Serial Interfaces.
Setting	Bit 2	Description
0	0	Normal Operation.
1	1	Resets both CLK device as well as its Serial Interfaces.
Setting	Bit 4&3	Description
0	00	Normal Operation – DAC PHSTR is Tri-Stated.
1	01	DAC PHSTR line is driven High.
2	10	DAC PHSTR line is driven Low.
3	11	Normal Operation – DAC PHSTR is Tri-Stated.
Setting	Bit 5	Description
0	0	DDS Activated and SHB put on hold.
1	1	Resets DDS Core (SHB samples are routed to the DAC)

Note 1: What is mentioned as DAC PHSTR line is the physical net on the board that connects together the FPGA to the PHSTR pin (DAC5686) as well as to J5 (+). In a multiple board system, one board can be used as a master and its PHSTR pin can be driven high or low and an other one as slave, in which case its DAC PHSTR pin must be tri-stated.

Note 2: The Reset bits don't get cleared automatically, so a device can remain reset while not used to reduce the global power consumption.

Test Register – 0x1.

Any 8-bit value written in this register can be read-back to check that the Comport used works properly.

Test Register – 0x1								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0								

ADCA Register 0 – 0x2.

For more details, refer to ADS5500 datasheet.

ADCA Register 0 – 0x2									
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
1	Reserved								
Default	'0000000'								
0	Reserved						PLL	Reserved	
Default	'000000'						'0'	'0'	

ADCA Register 0 – 0x2		
Setting	Bit 1	Description
0	0	PLL OFF – for sampling frequencies between 10 and 80 MHz
1	1	PLL ON – for sampling frequencies between 60 and 125 MHz

ADCA Register 1 – 0x3.

For more details, refer to ADS5500 datasheet.

ADCA Register 1 – 0x3									
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
1	Reserved					TP1	TP0	Reserved	
Default	'00000'					'0'	'0'	'0'	
0	Reserved								
Default	'00000000'								

ADCA Register 1 – 0x3			
Setting	TP1	TP0	Description
0	0	0	Normal Mode of Operation
1	0	1	All outputs are zeroes
2	1	0	All outputs are ones
3	1	1	Continuous stream of '10'

ADCA Register 2 – 0x4.

For more details, refer to ADS5500 datasheet.

ADCA Register 2 – 0x4								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	Reserved				PDN	Reserved		
Default	'000'				'0'	'000'		
0	Reserved							
Default	'00000000'							

ADCA Register 2 – 0x4		
Setting	PDN	Description
0	0	Normal Mode of Operation
1	1	Device in Power Down Mode

ADCB Register 0 – 0x5.

For more details, refer to ADS5500 datasheet.

ADCB Register 0 – 0x5									
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
1	Reserved								
Default	'0000000'								
0	Reserved						PLL	Reserved	
Default	'000000'						'0'	'0'	

ADCB Register 0 – 0x5		
Setting	Bit 1	Description
0	0	PLL OFF – for sampling frequencies between 10 and 80 MHz
1	1	PLL ON – for sampling frequencies between 60 and 125 MHz

ADCB Register 1 – 0x6.

For more details, refer to ADS5500 datasheet.

ADCB Register 1 – 0x6									
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
1	Reserved					TP1	TP0	Reserved	
Default	'00000'					'0'	'0'	'0'	
0	Reserved								
Default	'00000000'								

ADCB Register 1 – 0x6			
Setting	TP1	TP0	Description
0	0	0	Normal Mode of Operation

1	0	1	All outputs are zeroes
2	1	0	All outputs are ones
3	1	1	Continuous stream of '10'

ADCB Register 2 – 0x7.

For more details, refer to ADS5500 datasheet.

ADCB Register 2 – 0x7								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	Reserved				PDN	Reserved		
Default	'000'				'0'	'000'		
0	Reserved							
Default	'00000000'							

ADCB Register 2 – 0x7		
Setting	PDN	Description
0	0	Normal Mode of Operation
1	1	Device in Power Down Mode

DAC Register 0 – 0x8.

For more details, refer to DAC5686 datasheet.

DAC Register 0 – 0x8								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	atest					Version		
Default	'000000'					'000'		
1	Freq_int[7:0]							
Default	'00000000'							

DAC Register 1 – 0x9.

For more details, refer to DAC5686 datasheet.

DAC Register 1 – 0x9								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Freq_int[15:8]							
Default	'00000000'							
1	Freq_int[23:16]							
Default	'00000000'							

DAC Register 2 – 0xA.

For more details, refer to DAC5686 datasheet.

DAC Register 2 – 0xA								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Freq_int[31:24]							
Default	'00000000'							
1	Phase_int[7:0]							
Default	'00000000'							

DAC Register 3 – 0xB.

For more details, refer to DAC5686 datasheet.

DAC Register 3 – 0xB								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Phase_int[15:8]							
Default	'00000000'							
1	Mode[1:0]		Div[1:0]		Sel[1:0]		Counter	Full bypass
Default	'00'		'00'		'00'		'0'	'0'

DAC Register 4 – 0xC.

For more details, refer to DAC5686 datasheet.

DAC Register 4 – 0xC								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Ssb	Interl	Sinc	Dith	Sync Phstr	Nco	Sif4	Twos
Default	'0'	'0'	'0'	'0'	'0'	'0'	'0'	'0'
1	Dual_clk	DSS_gain[1:0]		Respect	Qflag	PLL_rng[1:0]		Rev_bus
Default	'0'	'00'		'0'	'0'	'00'		'0'

DAC Register 5 – 0xD.

For more details, refer to DAC5686 datasheet.

DAC Register 5 – 0xD								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Daca_offset[7:0]							
Default	'00000000'							
1	Daca_gain[7:0]							
Default	'00000000'							

DAC Register 6 – 0xE.

For more details, refer to DAC5686 datasheet.

DAC Register 6 – 0xE								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Daca_offset[10:8]			sleepa	Daca_gain[11:8]			
Default				'0'	'0000'			
1	Dacb_offset[7:0]							
Default	'00000000'							

DAC Register 7 – 0xF.

For more details, refer to DAC5686 datasheet.

DAC Register 7 – 0xF								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Dacb_gain[7:0]							
Default	'00000000'							
1	Dacb_offset[10:8]			sleepb	Dacb_gain[11:8]			
Default	'000'			'0'	'0000'			

CDCM7005 Register 0 – 0x10.

For more details, refer to CDCM7005 datasheet.

CDCM7005 Register 0 – 0x10								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	VCXO_divider[3:0]				Reference Divider[9:6]			
Default	'0000'				'0000'			
0	Reference Divider[5:0]						Register Selection[1:0]	
Default	'000000'						'00'	

CDCM7005 Register 1 – 0x11.

For more details, refer to CDCM7005 datasheet.

CDCM7005 Register 1 – 0x11								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	Freq Detect	Manual or Auto Ref.	Programmable Delay N[2:0]			Programmable Delay M[2:0]		
Default	'0'	'0'	'000'			'000'		
0	VCXO_divider[11:4]							
Default	'00000000'							

CDCM7005 Register 2 – 0x12.

For more details, refer to CDCM7005 datasheet.

CDCM7005 Register 2 – 0x12									
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
1	OUT2A0	OUT1B1	OUT1B0	OUT1A1	OUT1A0	OUT0B1	OUT0B0	OUT0A1	
Default	'0'	'0'	'0'	'0'	'0'	'0'	'0'	'0'	
0	OUT0A0	Output Signaling Selction[5:0]					Register Selection[1:0]		
Default	'0'	'00000'					'01'		

CDCM7005 Register 3 – 0x13.

For more details, refer to CDCM7005 datasheet.

CDCM7005 Register 3– 0x13								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	90Div8	90Div4	ADClock	Status VCXO	Status Ref	OUT4B1	OUT4B0	OUT4A1
Default	'0'	'0'	'0'	'0'	'0'	'0'	'0'	'0'
0	OUT4A0	OUT3B1	OUT3B0	OUT3A1	OUT3A0	OUT2B1	OUT2B0	OUT2A1
Default	'0'	'0'	'0'	'0'	'0'	'0'	'0'	'0'

CDCM7005 Register 4 – 0x14.

For more details, refer to CDCM7005 datasheet.

CDCM7005 Register 4 – 0x14									
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
1	Y0_MUX			Width FB_MUX			PDF Pulse		
Default	'000'			'000'			'00'		
0	CP Current				PRECP	CP_DIR	Register Selection[1:0]		
Default	'0000'				'0'	'0'	'10'		

CDCM7005 Register 5 – 0x15.

For more details, refer to CDCM7005 datasheet.

CDCM7005 Register 5– 0x15									
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
1	Hold	Reset	ResHold	Power Down	Y4_MUX			Y3_MUX	
Default	'0'	'0'	'0'	'0'	'000'			'0'	
0	Y3_MUX		Y2_MUX			Y1_MUX			
Default	'00'		'000'			'000'			

CDCM7005 Register 6 – 0x16.

For more details, refer to CDCM7005 datasheet.

CDCM7005 Register 6 – 0x16								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	Reserved				Hold	Reserved	Hold Function1	Reserved
Default	'0000'				'0'	'0'	'0'	'0'
0	Reserved	Cycle Slip	Lock Cycles		Lock Window		Register Selection[1:0]	
Default	'0'	'0'	'00'		'00'		'11'	

CDCM7005 Register 7 – 0x17.

For more details, refer to CDCM7005 datasheet.

CDCM7005 Register 7 – 0x17								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	Reserved							
Default	'00000000'							
0	Reserved							
Default	'00000000'							

Main Module Temperature (not implemented) – 0x18

Main Module Temperature – 0x18								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Temperature in Celcius Degrees							
Default	'00000000'							

Main Module FPGA Temperature (not implemented) – 0x19

Main Module FPGA Temperature – 0x19								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Temperature in Celcius Degrees							
Default	'00000000'							

Mezzanine Module Temperature (not implemented) – 0x1A

Mezzanine Module Temperature – 0x1A								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Temperature in Celcius Degrees							
Default	'00000000'							

Mezzanine Module Converters Temperature (not implemented) – 0x1B

Mezzanine Module Converters Temperature – 0x1B								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Temperature in Celcius Degrees							
Default	'00000000'							

Miscellaneous Register – 0x1C.

Miscellaneous Register – 0x1C								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Reserved		ADC Trigger - Selection	ADC Trigger - Polarity	ADC Trigger - Internal	ADCs Data	Clock Selection	Reference Selection
Default	'00'		'0'	'0'	'0'	'0'	'0'	'0'
1	Reserved		DAC Trigger - Selection	DAC Trigger - Polarity	DAC Trigger - Internal	Reserved	SHB Selection	
Default	'00'		'0'	'0'	'0'	'0'	'00'	
Miscellaneous Register – 0x1C								
Setting	Bit 13	Description						
0	0	Internal DAC Trigger (from register 0x1C – bit 11) selected.						
1	1	External DAC Trigger (from connector J24) selected.						
Miscellaneous Register – 0x1C								
Setting	Bit 12	Description						
0	0	Polarity DAC Trigger signal selected – Non-Inverting.						
1	1	Polarity DAC Trigger signal selected – Inverting.						
Miscellaneous Register – 0x1C								
Setting	Bit 11	Description						
0	0	Internal DAC Trigger set to '0'.						
1	1	Internal DAC Trigger set to '1'.						
Miscellaneous Register – 0x1C								
Setting	Bit 9/8	Description						
0	00	ADC Channel A and B ; 1 sample of each ADC channel packed onto one 32-bit word. [ChB ChA]						
1	01	ADC Channel A only ; 2 samples packed onto one 32-bit word [word(t+1) word(t)]						
2	10	ADC Channel B only ; 2 samples packed onto one 32-bit word [word(t+1) word(t)]						
3	11	ADC Channel A and B ; 1 sample of each ADC channel packed onto one 32-bit word. [ChB ChA]						
Miscellaneous Register – 0x1C								
Setting	Bit 5	Description						
0	0	Internal ADC Trigger (from register 0x1C – bit 3) selected.						
1	1	External ADC Trigger (from connector J24) selected.						
Miscellaneous Register – 0x1C								
Setting	Bit 4	Description						
0	0	Polarity ADC Trigger signal selected – Non-Inverting.						
1	1	Polarity ADC Trigger signal selected – Inverting.						
Miscellaneous Register – 0x1C								

Setting	Bit 3	Description
0	0	Internal ADC Trigger set to '0'.
1	1	Internal ADC Trigger set to '1'.
Miscellaneous Register – 0x1C		
Setting	Bit 2	Description
0	0	Binary Format.
1	1	2's Complement.
Miscellaneous Register – 0x1C		
Setting	Bit 1	Description
0	0	VCXO selection.
1	1	External Source Selected.
Miscellaneous Register – 0x1C		
Setting	Bit 0	Description
0	0	On-Board 10-MHz Reference Clock selected.
1	1	External Reference Selected.

Updates, Read-back and Firmware Version Registers – 0x1D

The Update bit activates the corresponding Serial Interface to pass registers previously written in the FPGA, into the corresponding device (ADCA, ADCB, DAC or CLK devices).

The Read-back bit activates the corresponding Serial Interface to read-back register values from the corresponding device and to pass them to the FPGA. This operation must be followed by Read-back register operations.

Note that only the DAC allows proper read-back operation. Other devices read-back commands would only perform a read-back of the FPGA register.

Update and Read-back commands – 0x1D								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Reserved	DDS Step Update	DDS Stop Update	DDS Start Update	CLK Update	DAC Update	ADCB Update	ADCA Update
Default	'0'	'0'	'0'	'0'	'0'	'0'	'0'	'0'
1						DAC Read-back		
Default	'0'	'0'	'0'	'0'	'0'	'0'	'0'	'0'

Reading-back this register returns the Firmware version as well as some Status signals coming from the CDCM7005.

Firmware Version – 0x1D								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Firmware Version							
Default	'00000000'							
1						CDCM7005 Status VCXO	CDCM7005 Status Ref	CDCM7005 Status Lock
Default	'0'	'0'	'0'	'0'	'0'	'0'	'0'	'0'

DDS Register 0 – Start Phase Increment LSB - 0x20

DDS Register 0 – 0x20								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	DDS Start Phase Increment[15...8]							
Default	'00000000'							
0	DDS Start Phase Increment [7...0]							
Default	'00000000'							

DDS Register 1 – Start Phase Increment MSB - 0x21

DDS Register 1 – 0x21								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	DDS Start Phase Increment [31...24]							
Default	'00000000'							
0	DDS Start Phase Increment [23...16]							
Default	'00000000'							

The Start Phase Increment value is coded on 32 bits (DDS Data registers 0x20 and 0x21). Each value corresponds to a frequency generated worked out as follows:

$$F_{out} = \text{Start Phase Increment} * F_{DAC \text{ sampling}} \text{ (MHz)} / 2^{32}$$

When the DDS is used in sweep mode, **Start Phase Increment** should be lower than **Stop Phase Increment** and **Step Phase Increment** should be greater than 0. When used to generate a fixed frequency, **Start Phase Increment** should be equal to **Stop Phase Increment** and **Step Phase Increment** should be equal to 1.

For Registers 0x20 and 0x21 to take effect, Bit 4 of register 0x1D must be set to 1.

DAC Channel A is the Sine output of the DDS and DAC Channel B is the Cosine output of the DDS. Both outputs are therefore is quadrature.

The Maximum Phase increment value supported by the design is 0x40000000, which corresponds to a frequency of 30.72MHz when sampling at 122.88MHz with no interpolation.

DDS Register 2 – Stop Phase Increment LSB - 0x22

DDS Register 2 – 0x22								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	DDS Stop Phase Increment [15...8]							
Default	'00000000'							
0	DDS Stop Phase Increment [7...0]							
Default	'00000000'							

DDS Register 3 – Stop Increment MSB - 0x23

DDS Register 3 – 0x23								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	DDS Stop Phase Increment [31...24]							
Default	'00000000'							
0	DDS Stop Phase Increment [23...16]							
Default	'00000000'							

The Stop Phase Increment value is coded on 32 bits (DDS Data registers 0x22 and 0x23). Each value corresponds to a frequency generated worked out as follows :

$$F_{out} = \text{Stop Phase Increment} * F_{DAC \text{ sampling}} \text{ (MHz)} / 2^{32}$$

When the DDS is used in sweep mode, **Start Phase Increment** should be lower than **Stop Phase Increment** and **Step Phase Increment** should be greater than 0. When used to generate a fixed frequency, **Start Phase Increment** should be equal to **Stop Phase Increment** and **Step Phase Increment** should be equal to 1.

For Registers 0x22 and 0x23 to take effect, Bit 5 of register 0x1D must be set to 1.

DAC Channel A is the Sine output of the DDS and DAC Channel B is the Cosine output of the DDS. Both outputs are therefore is quadrature.

The Maximum Phase increment value supported by the design is 0x40000000, which corresponds to a frequency of 30.72MHz when sampling at 122.88MHz with no interpolation.

DDS Register 0 – Step Phase Increment LSB - 0x24

DDS Register 4 – 0x24								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	DDS Step Phase Increment [15...8]							
Default	'00000000'							
0	DDS Step Phase Increment [7...0]							
Default	'00000000'							

DDS Register 5 – Step Increment MSB - 0x25

DDS Register 5 – 0x25								
Byte	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
1	DDS Step Phase Increment [31...24]							
Default	'00000000'							
0	DDS Step Phase Increment [23...16]							
Default	'00000000'							

The Step Phase Increment value is coded on 32 bits. It corresponds to the increment in phase on each sampling clock cycle (Sweep Mode).

When used to generate a fixed frequency, **Start Phase Increment** should be equal to **Stop Phase Increment** and **Step Phase Increment** should be equal to 1.

For Registers 0x24 and 0x25 to take effect, Bit 6 of register 0x1D must be set to 1.

DAC Channel A is the Sine output of the DDS and DAC Channel B is the Cosine output of the DDS. Both outputs are therefore in quadrature.

FPGA Design

The following block diagram shows how the default FPGA design is structured:

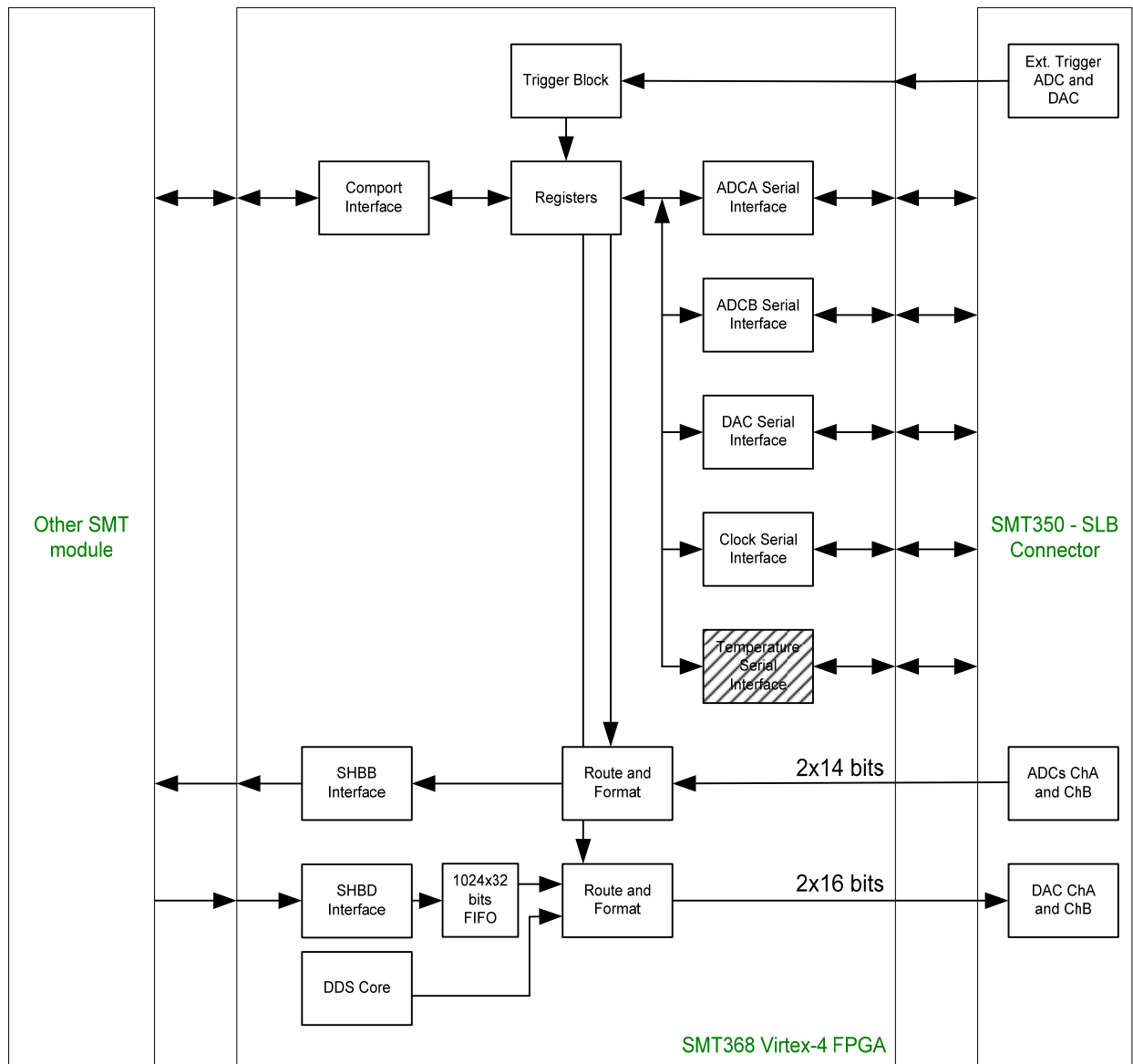


Figure 17 - Firmware Block Diagram.

Serial Interfaces

All serial interfaces have been designed in accordance with manufacturers datasheets and validated by probing and checking against timing provided.

Block of registers

This implements what has previously been described in this document.

Space available in FPGA

This is the summary provided by Xilinx ISE 7.1.04i regarding the amount of resources required by the default FPGA design – this is targeting a Virtex4 XC4V5X35.

Logic Utilization	Used	Available	Utilization	Note(s)
Number of Slice Flip Flops:	2,276	30,720	7%	
Number of 4 input LUTs:	2,292	30,720	7%	
Logic Distribution:				
Number of occupied Slices:	2,170	15,360	14%	
Number of Slices containing only related logic:	2,170	2,170	100%	
Number of Slices containing unrelated logic:	0	2,170	0%	
Total Number 4 input LUTs:	2,391	30,720	7%	
Number used as logic:	2,292			
Number used as a route-thru:	95			
Number used as Shift registers:	4			
Number of bonded IOBs:	194	448	43%	
Number of BUFG/BUFGCTRLs:	1	32	3%	
Number used as BUFGs:	1			
Number used as BUFGCTRLs:	0			
Number of FIFO16/RAMB16s:	8	192	4%	
Number used as FIFO16s:	0			
Number used as RAMB16s:	8			

Figure 18 - Space available in FPGA

PCB Layout

The following figures show the top and bottom view of the main module, the top view of the daughter-card and the module composition viewed from the side.



Figure 19 – Main Module Component Side.



Figure 20 - Main Module (SMT368) Solder Side.

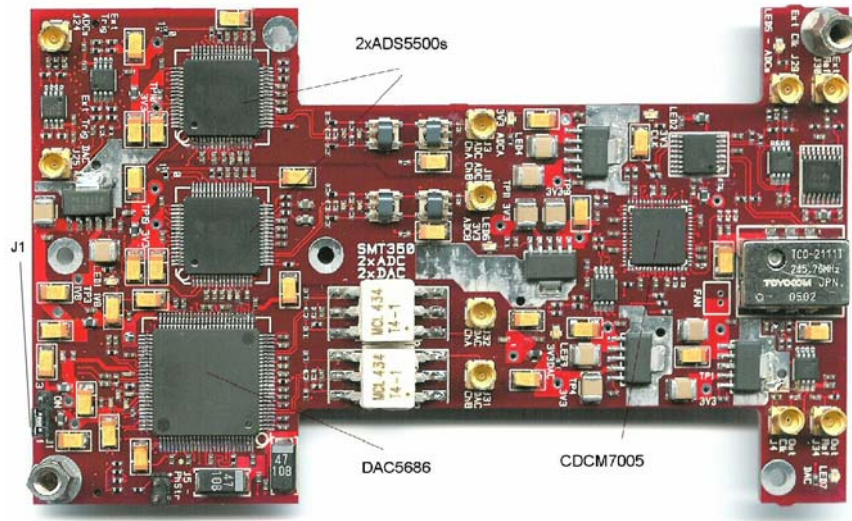


Figure 21 - Daughter Module Component Side.

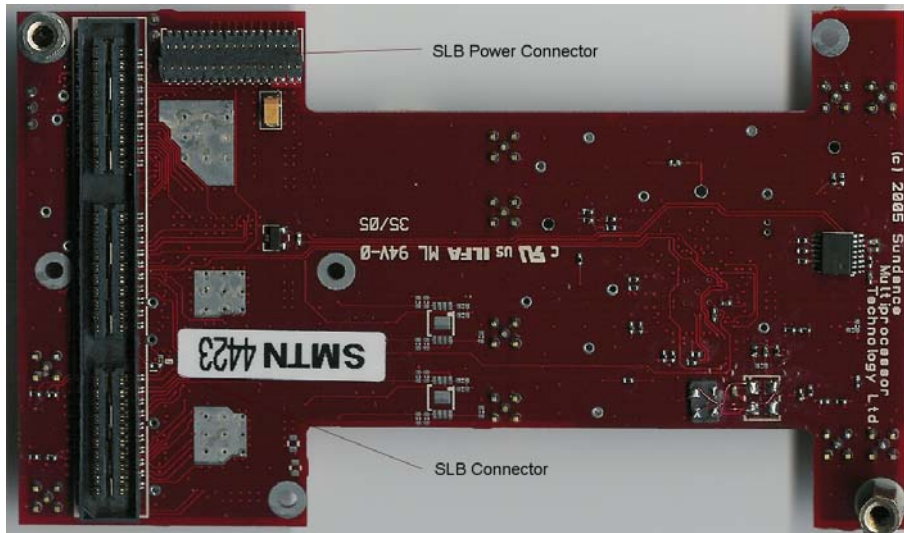


Figure 22 - Daughter Module Solder Side.

Connectors

Description

The following table gathers all connectors on the board and describes their function.

Connector name and (silkscreen schematics)	Description	Location on the board
J13	ADCA Analog Input	Middle / Left
J11	ADCB Analog Input	Middle / Left
J32	DACA Analog Output	Middle / Right
J31	DACB Analog Output	Middle / Right
J30	External Reference Input	Top / Left
J29	External Clock Input	Top / Left
J34	External Reference Output	Top / Right
J4	External Clock Output	Top / Right
J24	External Trigger ADCs	Bottom / Left
J25	External Trigger DAC	Bottom / Left

Location on the board

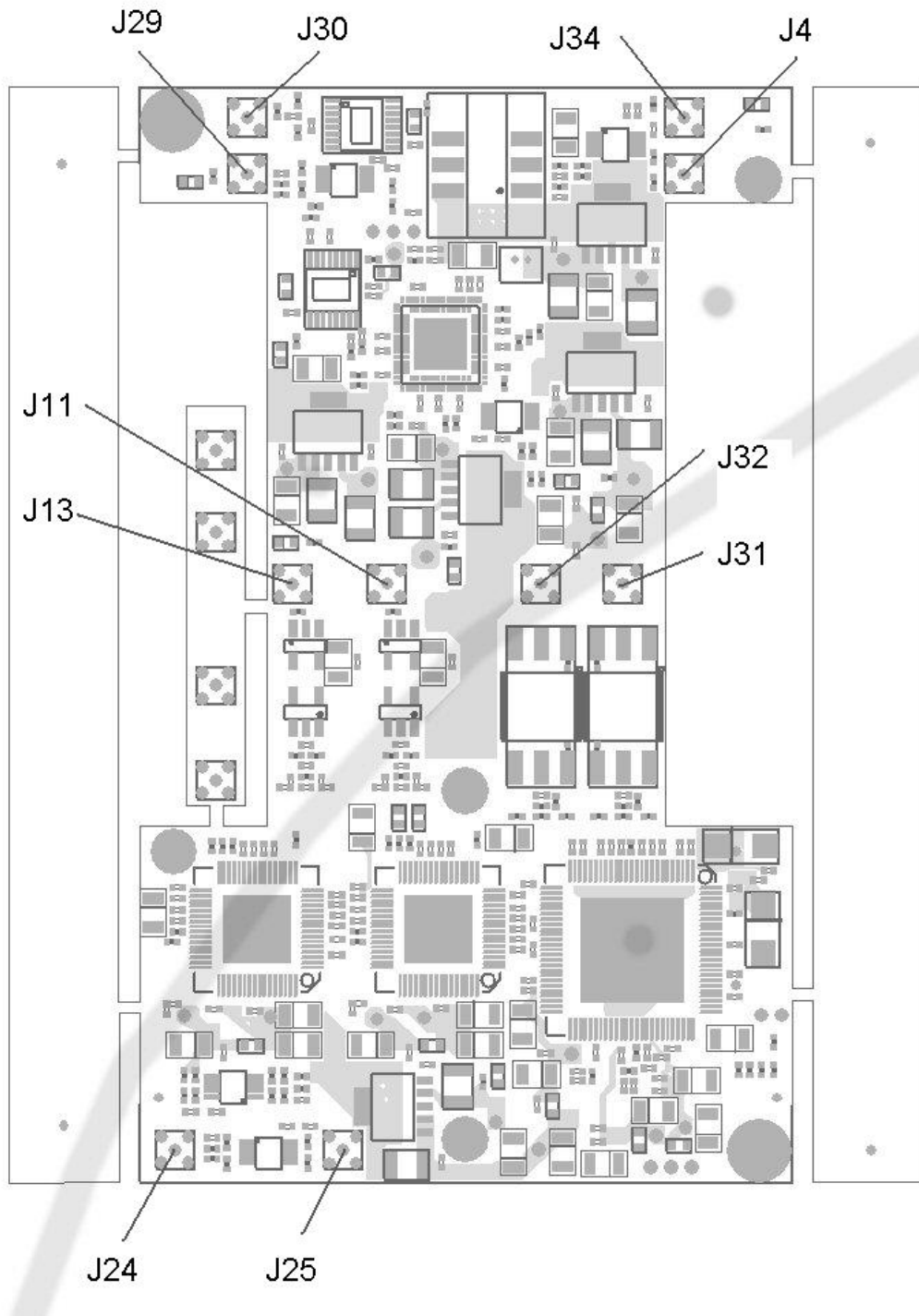


Figure 23 - Connectors Location.